

MJ P-Channel Enhancement Mode Power MOSFET

Description

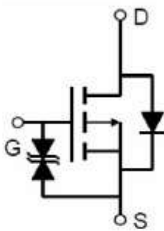
The MJ01P03S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protected.

General Features

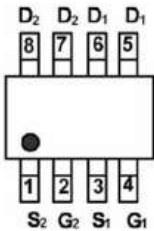
- ◆ $V_{DS} = -100V, I_D = -3A$
 $R_{DS(ON)} < 200m\Omega @ V_{GS} = -10V$ (Typ: 170m Ω)
 $R_{DS(ON)} < 230m\Omega @ V_{GS} = -4.5V$ (Typ: 200m Ω)
- ◆ Super high dense cell design
- ◆ Advanced trench process technology
- ◆ Reliable and rugged
- ◆ High density cell design for ultra low on-resistance

Application

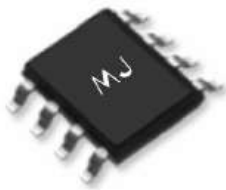
- ◆ Power switch
- ◆ DC/DC converters



Schematic diagram



Marking and pin Assignment



SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ01P03S	MJ01P03S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	-3	A
Drain Current-Continuous($T_c = 100^\circ C$)	$I_{D(100^\circ C)}$	-2.1	A
Pulsed Drain Current	I_{DM}	-20	A
Maximum Power Dissipation	P_D	2.5	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient ^(Note 2)	$R_{\theta JA}$	50	°C/W
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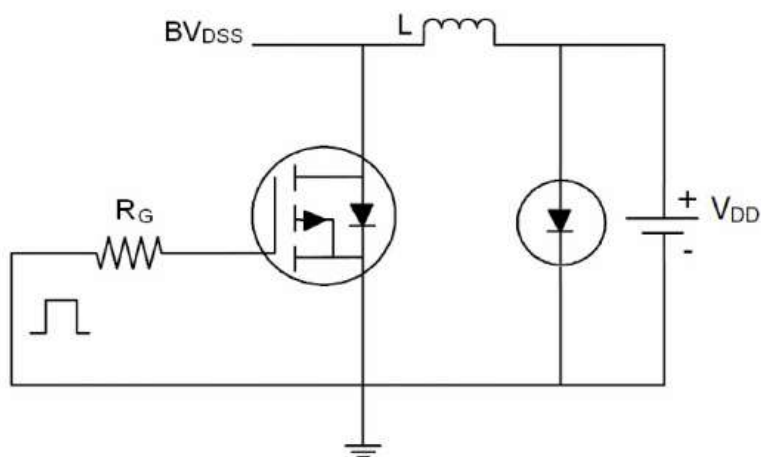
Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{DS} =±20V, V _{DS} =0V	-	-	±10	μA
On Characteristics <small>(Note 3)</small>						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.9	-3	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-3A	-	170	200	mΩ
		V _{GS} =-4.5V, I _D =-2A		200	230	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-3A	2	-	-	S
Dynamic Characteristics <small>(Note 4)</small>						
Input Capacitance	C _{iss}	V _{DS} =-25V, V _{GS} =0V F=1.0MHz	-	760	-	PF
Output Capacitance	C _{oss}		-	260	-	PF
Reverse Transfer Capacitance	C _{rss}		-	170	-	PF
Switching Characteristics <small>(Note 4)</small>						
Turn-on Delay Time	t _{d(on)}	V _{DD} =-50V, I _D =-3A V _{GS} =-10V, R _{GEN} =9Ω	-	14	-	nS
Turn-on Rise Time	t _r		-	18	-	nS
Turn-Off Delay Time	t _{d(off)}		-	50	-	nS
Turn-Off Fall Time	t _f		-	18	-	nS
Total Gate Charge	Q _g	V _{DS} =-50V, I _D =-3A V _{GS} =-10V	-	25	-	nC
Gate-Source Charge	Q _{gs}		-	5	-	nC
Gate-Drain Charge	Q _{gd}		-	7	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <small>(Note 3)</small>	V _{SD}	V _{GS} =0V, I _S =-3A	-	-	-1.2	V
Diode Forward Current <small>(Note 2)</small>	I _S		-	-	-3	A
Reverse Recovery Time	t _{rr}	T _J =25°C, I _F =-3A di/dt=100A/μs <small>(Note 3)</small>	-	35	-	nS
Reverse Recovery Charge	Q _{rr}		-	46	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible(turn-on is dominated by LS+LD)				

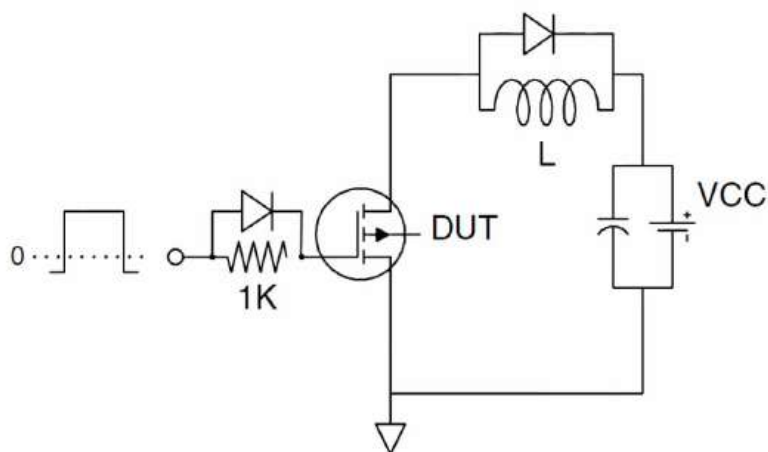
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- ⑤ EAS condition: T_J=25°C, V_{DD}=-50V, V_G=-10V, L=0.5mH, R_g=25Ω

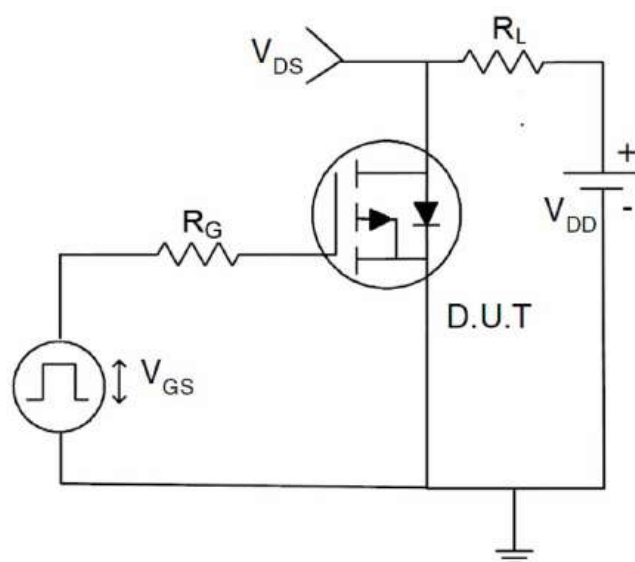
Test circuit



EAS test Circuit

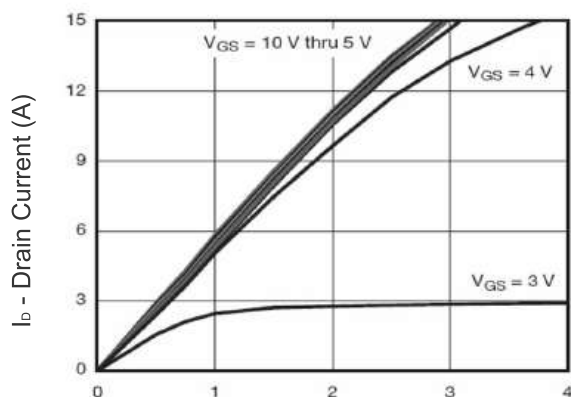


Gate charge test Circuit



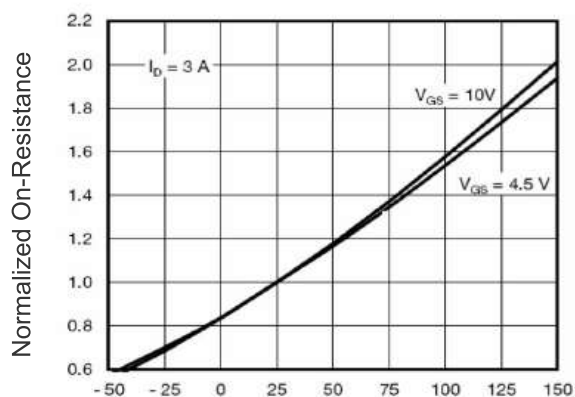
Switch Time Test Circuit

N-channel Typical Electrical and Thermal Characteristics (Curves)



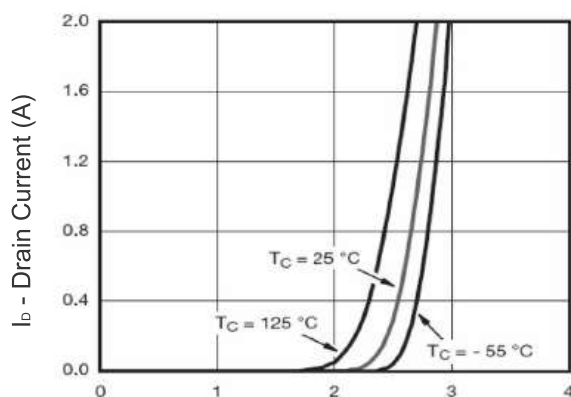
V_{ds} Drain-Source Voltage (V)

Figure 1 Output Characteristics



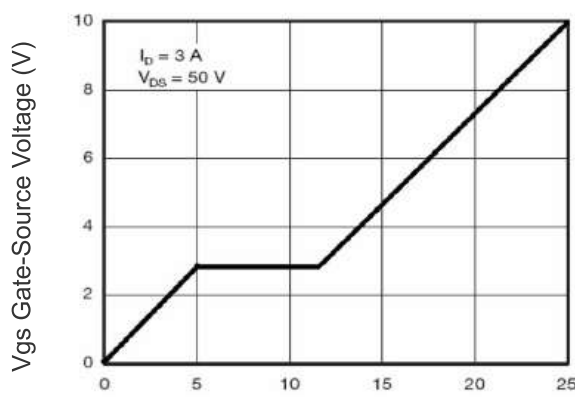
T_j -Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



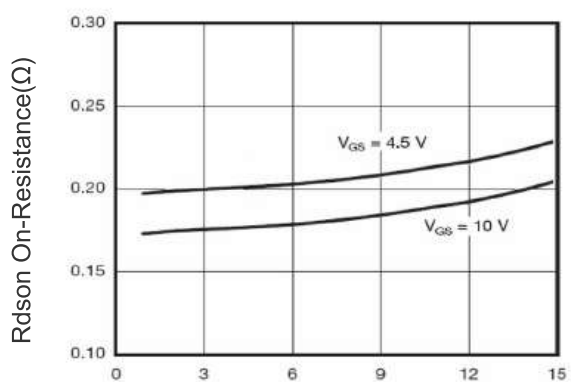
V_{gs} Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



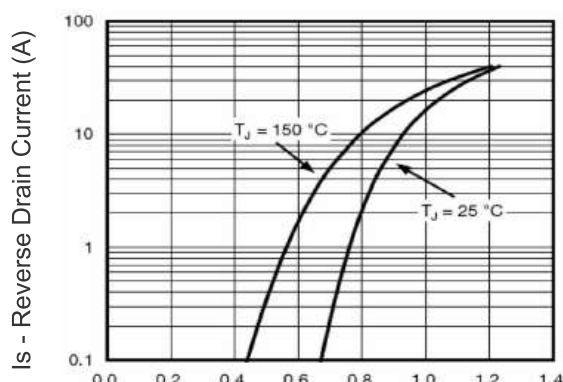
Q_g Gate Charge (nC)

Figure 5 Gate Charge



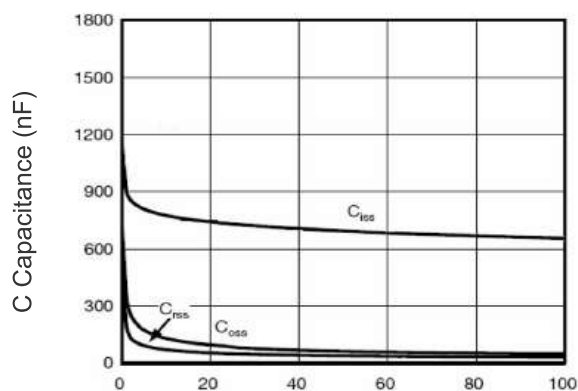
I_d - Drain Current (A)

Figure 3 Rdson- Drain Current



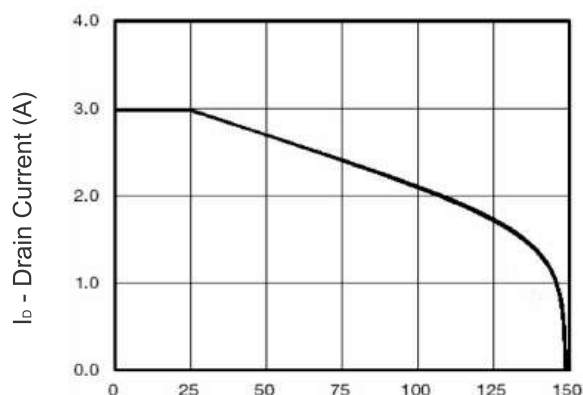
V_{sd} Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



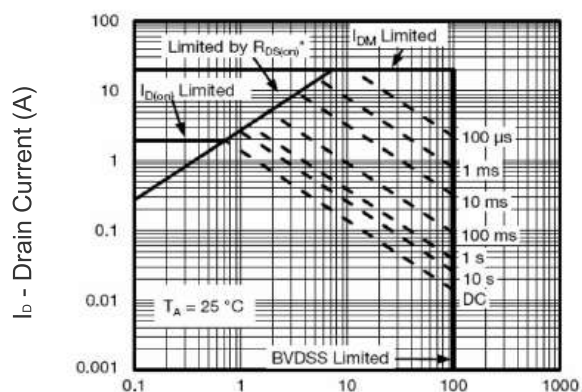
Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



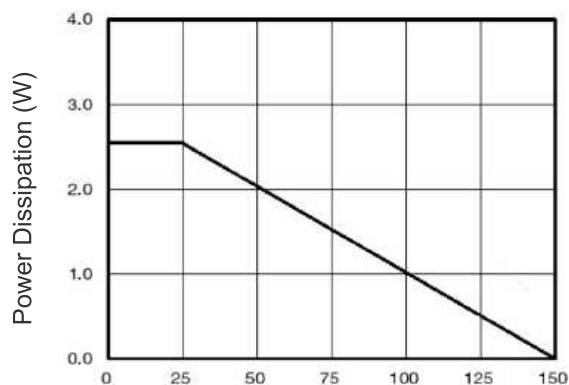
Tc Case Temperature(°C)

Figure 9 Drain Current vs Case Temperature



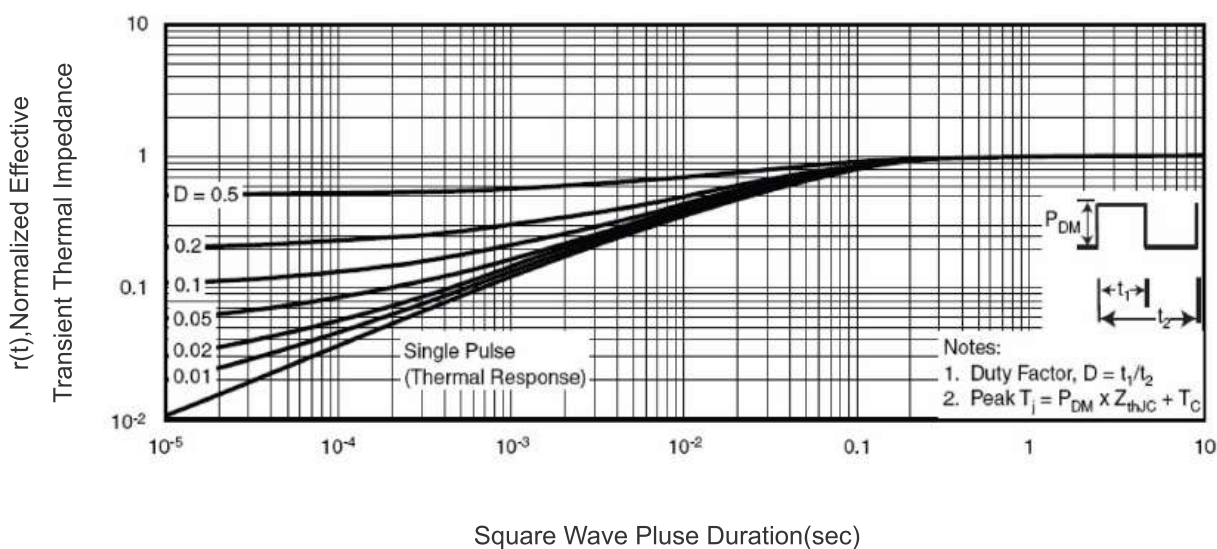
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



Tj -Junction Temperature(°C)

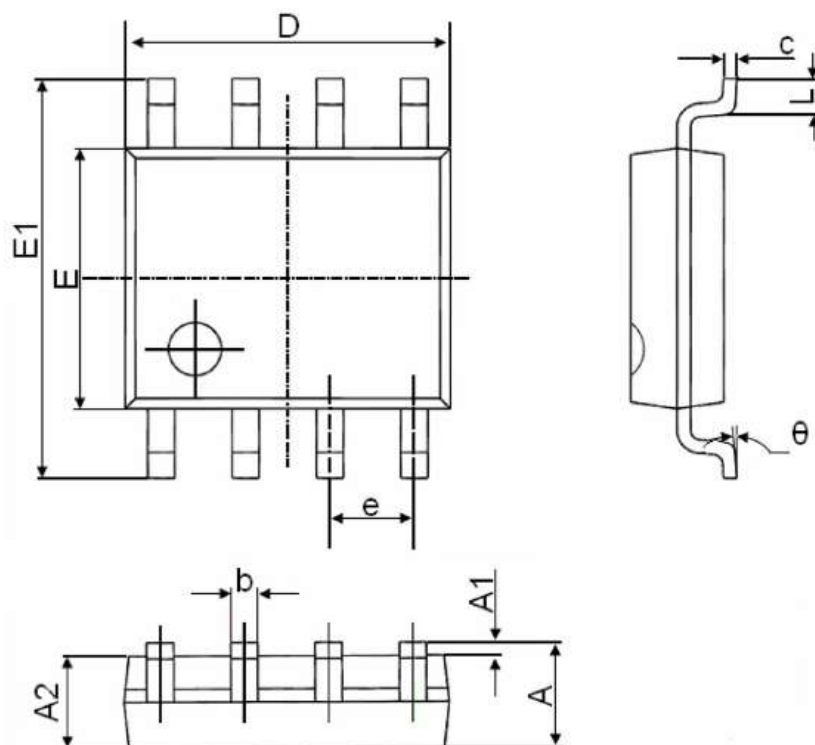
Figure 10 Power De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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